

SG F1 Smart Module



SG F1 Smart Module Owner's Manual

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SG

SG F1 Smart Module



Specifications

- **Product:** F1 Smart Module
- **Order Part Number:** SGW3501
- **Equipped with:** BLE, Wi-Fi, LoRa(WAN), and LTE CAT-M1/NB1/NB2
- **Microcontroller:** MicroPython programmable
- **Connectivity Options:** Various

Product Information

Introduction

The F1 Smart Module is a compact OEM module that supports BLE, Wi-Fi, LoRa(WAN), and LTE CAT-M1/NB1/NB2 connectivity options. It runs on a MicroPython programmable microcontroller and provides easy access to the SG Wireless Ctrl. Cloud Platform for IoT application development.

Order Part Number Description

Order Part Number	Description
SGW3531	F1's Smart Module: BLE, Wi-Fi, LoRa, LTE & Secure element
SGW3501	F1 Smart Module: BLE, Wi-Fi, LoRa, LTE

Module Interface

- **Power Management**
Instructions on how to manage power for the module.
- **Memory Allocation**
Guidelines for memory allocation for optimal performance.

Introduction

The F1 Smart Module (order part number SGW3501) is a compact OEM module equipped with BLE, Wi-Fi, LoRa(WAN), and LTE CAT-M1/NB1/NB2 to support various connectivity needs. Running on a MicroPython-

programmable microcontroller with a no-barrier entry into the SG Wireless Ctrl. Cloud Platform, the module enables truly limitless IoT application development with multi-network creation flexibility and rapid scaling capacity. The F1 Smart Module has four variants with various connectivity options; under each variant, there are two sub-variants with advanced security element options.

- Multi-connectivity:
 - Wi-Fi 802.11b/g/n (2.4GHz)
 - Bluetooth BLE 5.0
 - Cellular LTE-CAT M1/NB1/NB2
 - Semtech LoRa(WAN) 868MHz/915MHz
- Powerful Espressif ESP32 S3 CPU
- MicroPython programmable with 27 IOs on module pads
- SMT-friendly semi-hole pins at module edges
- Operating temperature: 0°C to 85°C
- Advanced Security IC NXP SE050 (for “s” suffix models)
- Compact size-to-functionality ratio: 42.6mm x 17.6mm x 3.6mm

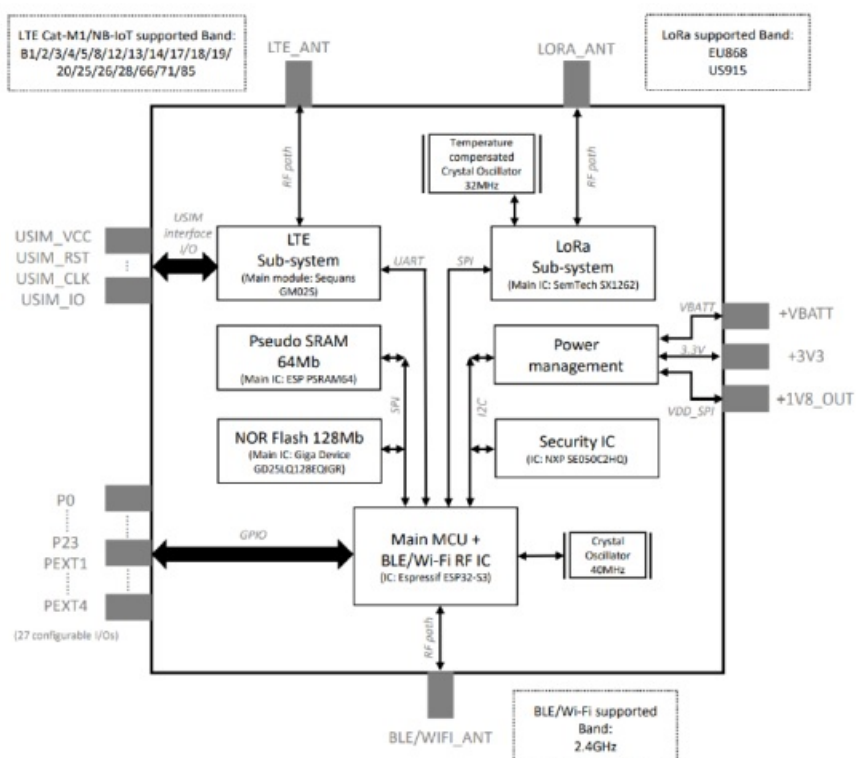
Order Part Number	Description
SGW3531	F1s Smart Module: BLE, Wi-Fi, LoRa, LTE & Secure element
SGW3501	F1 Smart Module: BLE, Wi-Fi, LoRa, LTE
SGW3431	F1/Cs Cellular Module: BLE, Wi-Fi, LTE & Secure element
SGW3401	F1/C LoRa Module: BLE, Wi-Fi, LTE
SGW3231	F1/Ls LoRa Module: BLE, Wi-Fi, LoRa & Secure element
SGW3201	F1/L LoRa Module: BLE, Wi-Fi, LoRa
SGW3131	F1/Ws Wi-Fi BLE Module: BLE, Wi-Fi & Secure element
SGW3101	F1/W Wi-Fi BLE Module: BLE, Wi-Fi

General Features

a. Feature Specifications

CPU
<ul style="list-style-type: none"> Xtensa® dual-core 32-bit LX7 microprocessor, up to 240Mhz On-chip 384KB ROM and 512KB SRAM, on-board 8MB PSRAM and 16MB Flash Deep Sleep Mode: 10µA
Wi-Fi/BLE
<ul style="list-style-type: none"> Espressif ESP32-S3 on-chip RF frontend Wi-Fi: IEEE 802.11b/g/n (2.4GHz band); Data Rate: 1M up to 54Mbps (MCS7); Max Tx Power: 20dBm BLE: Bluetooth LE 5.0, Bluetooth mesh; Data Rate: 125kbps to 2Mbps; Max Tx Power: 20dBm
LTE
<ul style="list-style-type: none"> Sequans Monarch2 GM02S for CAT-M1, CAT-NB1 and CAT-NB2 support LTE CAT-M1/NB1/NB2 transmit power up to +23dBm PTCRB and GCF 1.3 3GPP release 13 compliant; Operator Approval: Verizon, AT&T, T-Mobile, Vodafone, Orange
LoRa
<ul style="list-style-type: none"> Semtech SX1262 RF transceiver, 868/915MHz LPWAN Module TX Power: Up to +22dBm; Sensitivity: -127dBm LoRaWAN stack – Class A and Class C Device

b. Block Diagram



Electrical Specifications

a. Absolute Rating and Operating Conditions

Table 1: Absolute Rating and Operating Conditions Specifications

Symbol	Parameter	Min	Typ	Max	Unit
Absolute Rating					
+VBATT	Supply voltage to Sequans GM02S LTE module		5.0	5.8	V
+3V3	Supply voltage to Espressif ESP32-S3 and module main circuit	3.0	3.3	3.6	V
+1V8_OUT*	SPI supply voltage (output) of SPI flash and PSRAM for decoupling capacitor connection		1.8	2.3	V
T(OPR)	Operating temperature	-40		85	°C
Operating Conditions					
+VBATT	Supply voltage to Sequans GM02S LTE module	2.5	5.0	5.5	V
+3V3	Supply voltage to Espressif ESP32-S3 and module main circuit	3.2	3.3	3.4	V
+1V8_OUT*	SPI supply voltage (output) of SPI flash and PSRAM for decoupling capacitor connection	1.7	1.8	1.9	V
CPU IO (3.3V power domain, VDD=3.3V)					
VIH	Input high voltage for GPIOs	$0.75 \times V_{DD}$		$V_{DD} + 0.3$	V
VIL	Input low voltage for GPIOs	-0.3		$0.25 \times V_{DD}$	V
VOH	Input high voltage for GPIOs	$0.8 \times V_{DD}$			V
VOL	Input low voltage for GPIOs			$0.1 \times V_{DD}$	V
Radio IO (1.8V power domain)					
VIH	Input high voltage for GPIOs	1.26		1.8	V
VIL	Input low voltage for GPIOs	0		0.54	V
VOH	Input high voltage for GPIOs	1.44		1.8	V
VOL	Input low voltage for GPIOs	0		0.36	V

The +1V8_OUT pin is to connect an external capacitor to the module internal SPI flash and PSRAM for a more robust VDD_SPI supply. This pin should not be connected to any external circuits that may draw more than 20mA. The voltage of this pin will vary in module light sleep mode and approach zero in module deep sleep mode.

b. Wi-Fi

Standard: 802.11b/g/n (2.4GHz ONLY) – 1T1R

Table 2: Wi-Fi Specifications

Parameter	Description	Min	Typ	Max	Unit
General					
Freq. (EU)	Operating frequency (EU)	2.402		2.482	GHz
Ch. (EU)	Channel (EU)	1		13	
Freq. (US)	Operating frequency (US)	2.402		2.472	GHz
Ch. (US)	Channel (US)	1		11	
Power max. (EU /US)	Maximum power (EU/US)			20	dBm
Tx					
Tx Power @B – 1Mbps	Tx power at B mode with data rate 1Mbps		18	20	dBm
EVM (Peak) @B – 1Mbps	EVM(Peak) at B mode with data rate 1Mbps			8	%
Freq. Err. @B – 1Mbps	Frequency error at B mode with data rate 1Mbps	-40	0	40	kHz
Tx Power @G – 54Mbps	Tx power at G mode with data rate 54Mbps		16	20	dBm
EVM (RMS) @G – 54Mbps	EVM(RMS) at G mode with data rate 54Mbps			-25	dB
Freq. Err. @G – 54Mbps	Frequency error at G mode with data rate 54Mbps	-40	0	40	kHz
Tx Power @N20 – MCS7	Tx power at N mode with data rate MCS7 and 20MHz bandwidth		15	20	dBm
EVM (RMS) @N20 – MCS7	EVM rms at N mode with data rate MCS7 and 20MHz bandwidth			-27	dB
Freq. Err. @N20 – MCS7	Frequency error @ N mode with data rate MCS7 and 20MHz bandwidth	-40	0	40	kHz
Tx Power @B – 1Mbps	Tx power at B mode with data rate 1Mbps		18	20	dBm
Rx					
Rx Sens. @B – 1Mbps	Tx power at B mode with data rate 1Mbps		-92.0	-82.0	dBm
Rx Sens. @G – 54Mbps	Tx power at G mode with data rate 54Mbps		-76.5	-66.0	dBm

Rx Sens. @N20 – MCS7	Tx power at N mode with data rate MCS7 and 20MHz bandwidth		-71.4	-64.0	dBm
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c. Bluetooth

Standard: BLE 5.0 – 1T1

Table 3: Bluetooth Specifications

Parameter	Description	Min	Typ	Max	Unit
General					
Freq.	Operating frequency	2.4000		2.4835	GHz
Ch.	Channel	0		39	
Power max.	Maximum power			20	dBm
Tx					
Tx Power @Ch. 37 – 1 Mbps	Tx power at channel 37 (freq.=2402MHz) with data rate 1Mbps		17	20	dBm
Freq. Err. @Ch. 37 – 1Mbps	Frequency error at channel 37 (freq.=2402MHz) with data rate 1Mbps	-50	0	50	%
Tx Power @Ch. 38 – 1Mbps	Tx power at channel 38 (freq.=2426MHz) with data rate 1Mbps		17	20	kHz
Freq. Err. @Ch. 38 – 1Mbps	Frequency error at channel 38 (freq.=2426MHz) with data rate 1Mbps	-50	0	50	dBm
Tx Power @Ch. 39 – 1Mbps	Tx power at channel 39 (freq.=2480MHz) with data rate 1Mbps		17	20	dBm
Freq. Err. @Ch. 39 – 1Mbps	Frequency error at channel 39 (freq.=2480MHz) with data rate 1Mbps	-50	0	50	kHz
Rx					
Rx Sens. @Ch. 38 – 2Mbps	Tx power at channel 38 (freq.=2426MHz) with data rate 2Mbps		-93.5		dBm
Rx Sens. @Ch. 38 – 1Mbps	Tx power at channel 38 (freq.=2426MHz) with data rate 1Mbps		-97.5	-70.0	dBm
Rx Sens. @Ch.38 – 500kbps	Tx power at channel 38 (freq.=2426MHz) with data rate 500kbps		-100.0		dBm

d. LTE

Standard: CAT-M1, CAT-NB1, CAT-NB2

Table 4: LTE Frequency Bands (in MHz)

Band No.	Duplex Type	Uplink Frequency (MHz)	Uplink Bandwidth (MHz)	Downlink Frequency (MHz)	Downlink Bandwidth (MHz)	For LTE-M	For NB-IoT
1	FDD	1920 – 1980	60	2110 – 2170	60	ü	ü
2	FDD	1850 – 1910	60	1930 – 1990	60	ü	ü
3	FDD	1710 – 1785	75	1805 – 1880	75	ü	ü
4	FDD	1710 – 1755	45	2110 – 2155	45	ü	ü
5	FDD	824 – 849	25	869 – 894	25	ü	ü
8	FDD	880 – 915	35	925 – 960	35	ü	ü
12	FDD	699 – 716	17	729 – 746	17	ü	ü
13	FDD	777 – 787	10	746 – 756	10	ü	ü
14	FDD	788 – 798	10	758 – 768	10	ü	ü
17	FDD	704 – 716	12	734 – 746	12	ü	ü
18	FDD	815 – 830	15	860 – 875	15	ü	ü
19	FDD	830 – 845	15	875 – 890	15	ü	ü
20	FDD	832 – 862	30	791 – 821	30	ü	ü
25	FDD	1850 – 1915	65	1930 – 1995	65	ü	ü
26	FDD	814 – 849	35	859 – 894	35	ü	ü
28	FDD	703 – 748	45	758 – 803	45	ü	ü
66	FDD	1710 – 1780	70	2110 – 2200	90	ü	ü
85	FDD	698 – 716	18	728 – 746	18	ü	ü

Table 5: LTE Specifications

Parameter	Description	Min	Typ	Max	Unit
General					
Power max.	Maximum power			23	dBm
Tx					
Tx power @Band 8 (900MHz GSM)	Tx power at Band 8 (900MHz GSM)		22	23	dBm
Tx power @Band 2 (1900MHz PCS)	Tx power at Band 2 (1900MHz PCS)		22	23	dBm
Rx					
Rx sens. @Band 8 (900MHz GSM)	Rx sensitivity at Band 8 (900MHz GSM)		-103	-100	dBm
Rx sens. @Band 2 (1900MHz PCS)	Rx sensitivity at Band 2 (1900MHz PCS)		-103	-100	dBm

e. LoRa

- **Mode:** LoRa RAW mode and LoRa WAN mode
- **LoRaWAN Node Type:** Class Type A, Class Type C
- **Frequency Band:** EU868, US915

Table 6: LoRa Specifications

Parameter	Description	Min	Typ	Max	Unit
General					
Freq. (EU)	Frequency band (EU)	863		870	GHz
Freq. (US)	Frequency band (US)	902		928	GHz
Power max. (EU)	Maximum power (EU)			15	dBm
Power max. (US)	Maximum power (US)			22	dBm
Tx					
Tx power (Tx tone) @ @866.4MHZ [EU868 band]	Tx power (Tx tone) at 866.4 MHz		14	15	dBm
Tx power (Tx tone) @918.2MHZ [US915 band]	Tx power (Tx tone) at 918.2 MHz		21	22	%
Rx					
Rx Sens. @freq=866.4MHz, BW=500kHz, SF=12	Rx sensitivity at 866.4MHz, 500kHz bandwidth and SF=12		-127		dBm
Rx Sens. @freq=866.4MHz, BW=500kHz, SF=12	Rx sensitivity at 866.4MHz, 500kHz bandwidth and SF=12		-127		dBm

Module Interface

a. Power Management

Table 7: Power Consumption by Mode of Operation

Mode of Operation	Min	Typ	Max	Unit
Idle (no radio, but MicroPython is running)		30		mA
Light sleep (wake up or restart is required for MicroPython to run)		800		µA
Deep sleep (wake up or restart is required for MicroPython to run)		10		µA

b. Memory Allocation

Module OS firmware, OTA, and user space sizes:

- Module OS firmware: 2,560Kb
- OTA1 space: 2,560Kb
- OTA2 space: 2,560Kb
- User space: 8Mb

Mechanical Data

a. Mechanical Specification

All pins have a pin width of 0.7mm except pin VBATT (pin #A4) with a pin width of 1.0mm

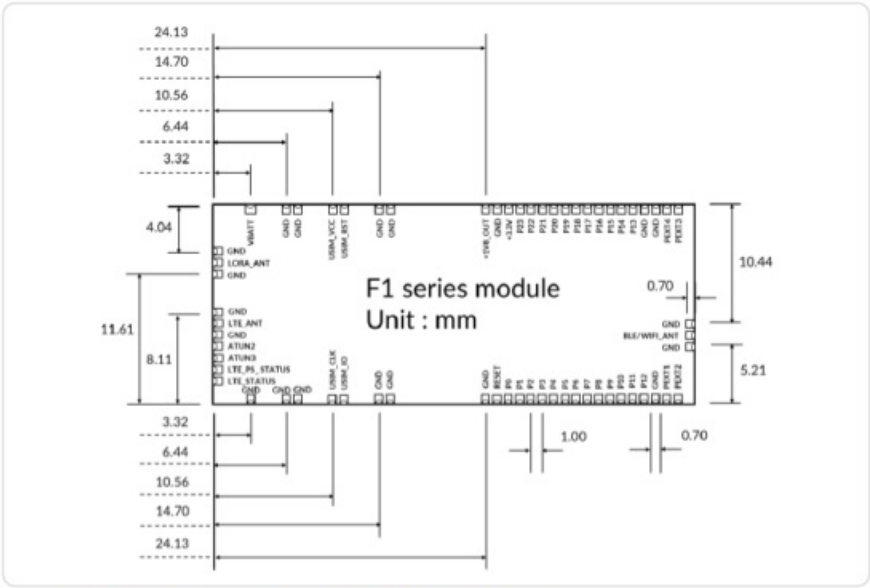


Figure 2: F1 Smart Module Pin Dimensions, Pin Pitches and Pin Locations (Top View)

b. Module Pin-out

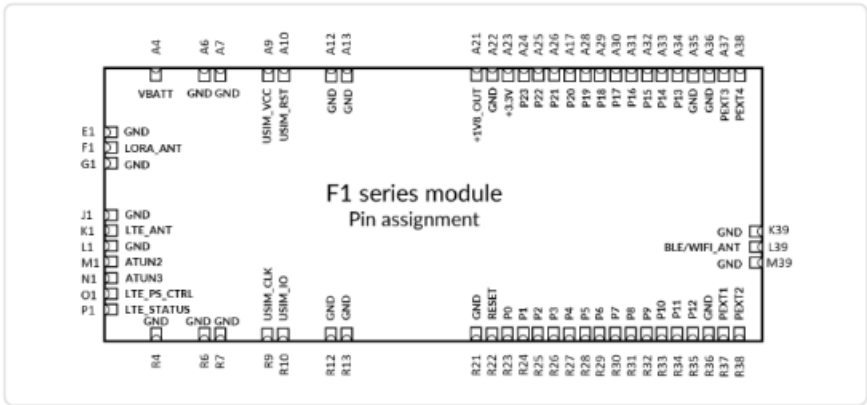


Figure 3: F1 Smart Module Pin-out (Top View)

Table 8: F1 Smart Module Pin-out

Pin Number	Pin Name	MCU Pin	LTE Module Pin	Type	Description
R4	GND			Power	Ground signal
R6	GND			Power	Ground signal
R7	GND			Power	Ground signal
R9	USIM_CLK		SIM0_CLK	Analog I/O	USIM interface I/O to GM02S
R10	USIM_IO		SIM0_IO	Digital I/O	USIM interface I/O to GM02S
R12	GND			Power	Ground signal
R13	GND			Power	Ground signal
R21	GND			Power	Ground signal
R22	RESET	CHIP_PU		Analog I/O	Reset the pin to ESP32-S3 for module reset
R23	P0	U0RXD		Analog I/O	UART0 RXD to ESP32-S3
R24	P1	U0TXD		Analog I/O	UART0 TXD to ESP32-S3
R25	P2	GPIO0		Analog I/O or Digital I/O	Analog I/O or Digital I/O to ESP32-S3
R26	P3	GPIO4		Analog I/O or Digital I/O	Analog I/O or Digital I/O to ESP32-S3
R27	P4	MTDO		Digital I/O	Digital I/O to ESP32-S3
R28	P5	GPIO5		Analog I/O or Digital I/O	Analog I/O or Digital I/O to ESP32-S3
<i>*R29</i>	<i>P6</i>	<i>GPIO6</i>			<i>Reserved – Leave floating, do not connect.</i>

R30	P7	GPIO3		Analog I/O or Digital I/O	Analog I/O or Digital I/O to ESP32-S3
R31	P8	GPIO46		Digital I/O	Digital I/O to ESP32-S3
R32	P9	GPIO45		Digital I/O	Digital I/O to ESP32-S3
R33	P10	MTCK		Digital I/O	Digital I/O to ESP32-S3
R34	P11	GPIO11		Analog I/O or Digital I/O	Analog I/O or Digital I/O to ESP32-S3
R35	P12	GPIO21		Analog I/O or Digital I/O	Analog I/O or Digital I/O to ESP32-S3
R36	GND			Power	Ground signal

R37	PEXT1	GPIO1		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3
R38	PEXT2	GPIO12		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3
M39	GND			Power	Ground signal
L39	BLE/WIFI_ ANT			RF I/O	RF interface to ESP32-S3 for BLE and/or Wi-Fi interface
K39	GND			Power	Ground signal
A38	PEXT4	GPIO14		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3
A37	PEXT3	GPIO13		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3
A36	GND			Power	Ground signal
A35	GND			Power	Ground signal
A34	P13	GPIO20		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3 /USB OTG D+
A33	P14	GPIO19		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3 /USB OTG D-
A32	P15	GPIO38		Digital I/O	Digital I/O to ESP32-S3
A31	P16	GPIO41		Digital I/O	Digital I/O to ESP32-S3
A30	P17	GPIO2		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3
A29	P18	GPIO10		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3
A28	P19	GPIO15		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3
A27	P20	GPIO16		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3
A26	P21	GPIO17		Analog I/O or Digital I/ O	Analog I/O or Digital I/O to ESP32-S3

A25	P22	GPIO18		Analog I/O or Digital I/O	Analog I/O or Digital I/O to ESP32-S3
A24	P23	GPIO42		Digital I/O	Digital I/O to ESP32-S3
A23	+3.3V	VDD3P3_C PU VDD3P3 _RTC VDD3 P3 VDDA		Power	Voltage supply to ESP32-S3 and module main circuit
A22	GND			Power	Ground signal

A21	+1.8V_OUT	VDD_SPI		Power	Voltage supply VDD_SPI to ESP32-S3 for SPI flash and PSRAM
A13	GND			Power	Ground signal
A12	GND			Power	Ground signal
A10	USIM_RST		SIM0_RSTN	Digital I/O	USIM interface I/O to GM02S
A9	USIM_VCC		SIM0_VCC	Power	USIM voltage supply to GM02S
A7	GND			Power	Ground signal
A6	GND			Power	Ground signal
A4	+VBATT		VBAT	Power	Voltage supply to GM02S
E1	GND			Power	Ground signal
F1	LORA_ANT			RF I/O	RF interface to SX1262 for LoRa interface
G1	GND			Power	Ground signal
J1	GND			Power	Ground signal
K1	LTE_ANT		LTE_ANT	RF I/O	RF interface to GM02S for LTE CAT-M1/CAT-NB1/CAT-NB2 interface
L1	GND			Power	Ground signal
M1	ATUN2		GPIO34/ ANT_TUNE0	Analog I/O	ANT_TUNE I/O to GM02S
N1	ATUN3		GPIO35/ ANT_TUNE1	Analog I/O	ANT_TUNE I/O to GM02S
O1	LTE_PS_CTRL		GPIO2/ PS_STATUS	Digital I/O	Power saving status I/O from GM02S
P1	LTE_STATU S		GPIO1/ STATUS_LED	Digital I/O	LTE status I/O from GM02S

c. Recommended PCB Landing Pattern

All pins have a pin width of 0.7mm, except pin VBATT (pin #A4) with a pin width of 1.0mm.

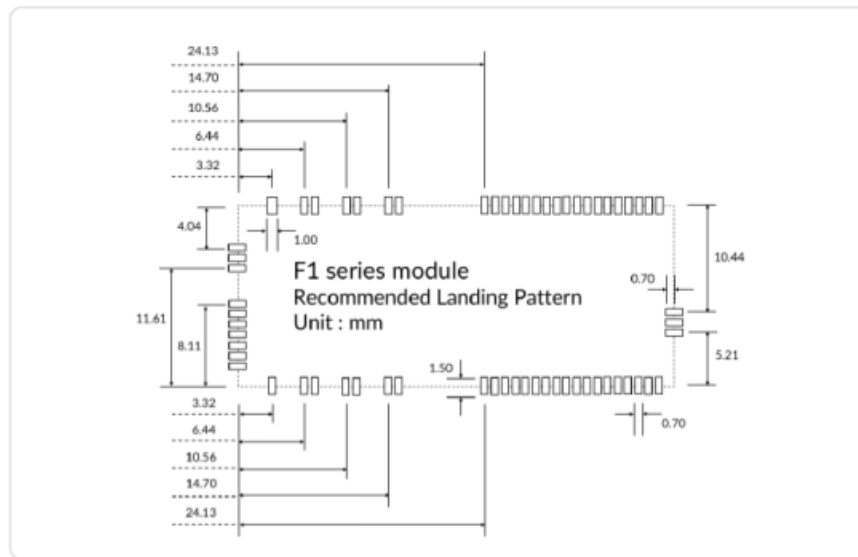


Figure 4: F1 Smart Module Recommended PCB Landing Pattern (Top View)

d. Recommended Basic Circuit

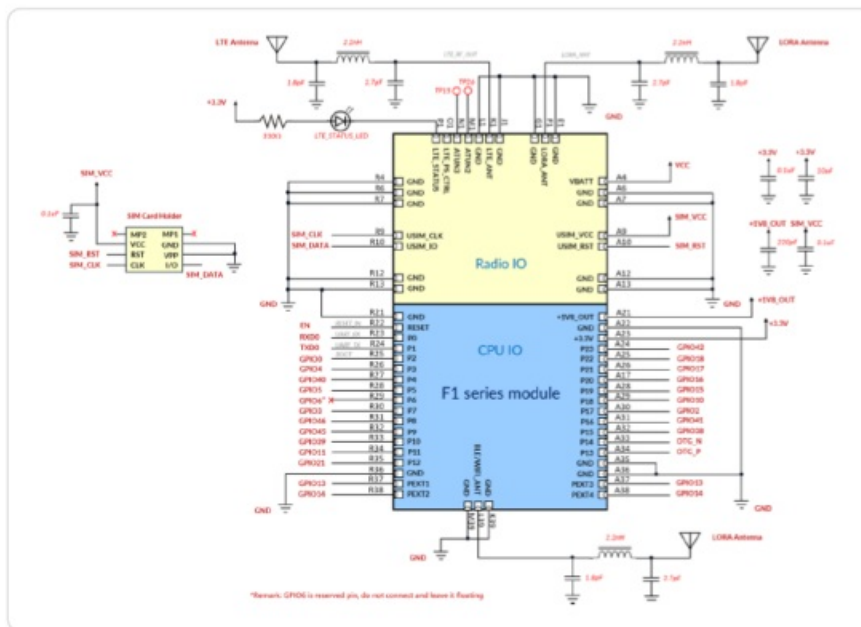


Figure 5: F1 Smart Module Recommended Basic Circuit

e. Recommended Soldering Profile

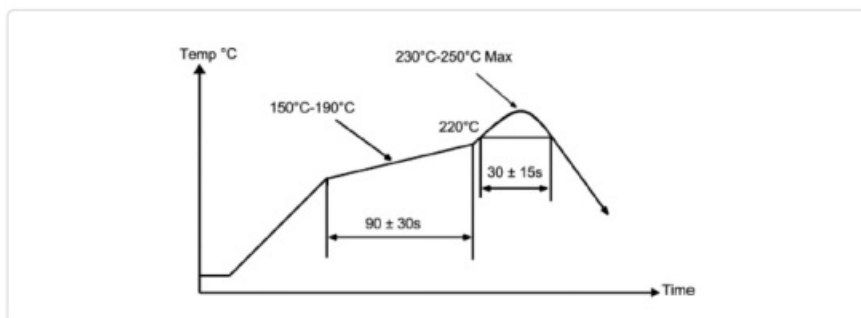


Figure 6: F1 Smart Module Recommended Reflow Soldering Profile

MicroPython Application Development on F1

a. Device Programming via UART

- By default, the F1 Smart Module runs an interactive python REPL (Read-Eval-Print-Loop) on UART0, which is connected to P0 (RX) and P1 (TX) running at 115200 baud.
- The Module can be connected via a development board or any USB UART adapter. Code can be run via the REPL and the SG Wireless CtrlR. The Visual Studio Code plug-in can also be used to upload code to the board.

b. Module-supported Libraries

Table 9: F1 Smart Module Supported Libraries

Library	Min
Python Standard Libraries*	array, aysncio, binascii, builtins, cmath, collections, errno, gc, gzip, hashlib, heap q, io, json, math, os, platform, random, re, select, socket, ssl, struct, sys, time, zli b, _thread
MicroPython-specific Librarie s*	Bluetooth, btree, cryptolib, deflate, framebuf, machine, micropython, neopixel, ne twork, uctypes, esp, esp32
F1 Smart Module-Specific Li braries†	lte: Ready-to-use LTE CAT-M1/NB1/NB2 library lorawan: Ready-to-use LoRa RAW and full stack LoRa WAN device Class A, Class C library ctrl: Ready-to-use Ctrl Cloud Platform client library

- MicroPython documentation library with API function calls (<https://docs.micropython.org/en/latest/library/>).
- SG Wireless F1 Smart Module documentation library with API function calls.

c. MicroPython Capability – REPL (Read-Eval-Print Loop)

The MicroPython-ready F1 Smart Module carries the REPL shell that can execute codes in real time, as well as enable section-by-section of code execution through a copy-and-paste function, both of which facilitate real-time debugging and instant application code prototyping.

```

COM10 - Term VT
File Edit Setup Control Window Help
help()
Welcome to MicroPython on the ESP32!
For generic online docs please visit https://docs.micropython.org/
For access to the hardware use the 'machine' module:

import machine
pin12 = machine.Pin(12, machine.Pin.IN)
pin12.value(1)
pin13 = machine.Pin(13, machine.Pin.IN, machine.Pin.PULL_UP)
print(pin13.value())
i2c = machine.I2C(scl=machine.Pin(21), sda=machine.Pin(22))
i2c.scan()
i2c.writeto(addr, b"1234")
i2c.readfrom(addr, 4)

Basic WiFi configurations
import network
sta_if = network.WiFi(network.STA_IF); sta_if.active(True)
sta_if.scan() # Scan for available access points
sta_if.connect("SSID name", "password") # Connect to an AP
sta_if.isconnected() # Check for successful connection

Control commands:
CTRL-A -- on a blank line, enter raw REPL mode
CTRL-B -- on a blank line, enter normal REPL mode
CTRL-C -- interrupt a running program
CTRL-D -- on a blank line, do a soft reset of the board
CTRL-E -- on a blank line, enter paste mode
CTRL-F -- do hard reset in safeboot mode

For further help on a specific object, type help(obj)
For a list of available modules, type help('modules')
>>>

```

Figure 7: F1 Smart Module Code Sample in REPL Shell

Product Packaging

les are packed in tape-and-reel packaging and shipped out in carton boxes.

<p>a. Tape MSL (Moisture sensitivity level): 1</p>	
<p>b. Reel 250pcs per reel</p>	
<p>c. Box</p>	

Certification

a. CE Statements

- **EU Declaration of Conformity (DOC)**

Hereby, SG Wireless Limited declares that the F1 Smart Module series complies with Radio Equipment Directive (RED) 2014/53/EU.

The full text of the EU declaration of conformity is available at the following Internet address:

<https://docs.sgwireless.com>

- RF exposure statement

RF exposure information: The Maximum Permissible Exposure (MPE) level has been calculated based on a distance of $d=20\text{cm}$ between the device and the human body. To maintain compliance with RF exposure requirements, use a product that maintains a 20cm distance between the device and human body.

- **CE marking and labeling**

By complying with CE standards, all modules are laser printed with “CE” markings and part numbers on the surface of the module shield, and manufacturer information is printed on labels on the shipping boxes/packages.

CE marking on module:



Manufacturer information on the shipping package/box:



b. FCC Statements

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

1. This device may not cause harmful interference.
2. This device must accept any interference received, including interference that may cause undesired operation.

CAUTION:

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

NOTE:

This equipment has been tested and found to comply with the limits for a Class B digital device, under Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates uses and can radiate radio frequency energy and, if not installed and used by the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

FCC Radiation Exposure Statement:

This equipment complies with FCC radiation exposure limits set forth for an uncontrolled environment. This equipment should be installed and operated with a minimum distance of 20cm between the radiator & your body.

OEM INTEGRATION INSTRUCTIONS:

- This device is intended only for OEM integrators under the following conditions:
- The module must be installed in the host equipment such that 20 cm is maintained between the antenna and users, and the transmitter module may not be co-located with any other transmitter or antenna. The module shall be only used with the internal on-board antenna that has been originally tested and certified with this module.
- External antennas are not supported.
- As long as these 3 conditions above are met, further transmitter tests will not be required.
- However, the OEM integrator is still responsible for testing their end-product for any additional compliance requirements required with this module installed (for example, digital device emissions, PC peripheral requirements, etc.).
- The end-product may need Verification testing, Declaration of Conformity testing, a Permissive Class II Change, or new Certification.
- Please involve a FCC certification specialist to determine what will be exactly applicable for the end-product.

Validity of using the module certification:

If these conditions cannot be met (for example, certain laptop configurations or co-location with another transmitter), then the FCC authorization for this module in combination with the host equipment is no longer considered valid, and the FCC ID of the module cannot be used on the final product. In these circumstances, the OEM integrator will be responsible for re-evaluating the end product (including the transmitter) and obtaining a separate FCC authorization. In such cases, please involve a FCC certification specialist to determine if a Permissive Class II Change or new Certification is required.

Upgrade Firmware:

The software provided for firmware upgrade will not be capable of affecting any RF parameters as certified for the FCC for this module to prevent compliance issues. End product labeling: This transmitter module is authorized only for use in devices where the antenna may be installed such that 20 cm may be maintained between the antenna and users. The end product must be labeled in a visible area with the following: "Contains FCC ID: 2AS9406" (for F1), "Contains FCC ID: 2AS9407" (for F1/C), "Contains FCC ID: 2AS9408" (for F1/L), "Contains FCC ID: 2AS9409" (for F1/W), "Contains FCC ID: 2AS9410" (for F1s), "Contains FCC ID: 2AS9411" (for F1/Cs), "Contains FCC ID: 2AS9412" (for F1/Ls), "Contains FCC ID: 2AS9413" (for F1W/s).

Information that must be placed in the end user manual:

The OEM integrator has to be aware not to provide information to the end user regarding how to install or remove this RF module in the user manual of the end product that integrates this module. The end-user manual shall include all required regulatory information/warnings as shown in this manual.

"CAUTION :

Exposure to Radio Frequency Radiation. The antenna shall be mounted in such a manner to minimize the potential for human contact during normal operation. The antenna should not be contacted during operation to

avoid the possibility of exceeding the FCC radio frequency exposure limit.

Orderable part number/Model no. comparison table

Orderable part number	Model no.	BLE/Wi-Fi	LTE Cat-M1/ N B-IoT	LoRa(WAN)	Security element
SGW3531	F1s	ü	ü	ü	ü
SGW3501	F1	ü	ü	ü	û
SGW3431	F1/Cs	ü	ü	û	ü
SGW3401	F1/C	ü	ü	û	û
SGW3231	F1/Ls	ü	û	ü	ü
SGW3201	F1/L	ü	û	ü	û
SGW3131	F1/Ws	ü	û	û	ü
SGW3101	F1/W	ü	û	û	û

Revision History

Version	Released Date	Description
1.0	Feb 7, 2024	Initial document release
1.1	Mar 6, 2024	Branding revised with updates: Introduction: Operaforure updated Section 4: PIN updated (A38 and A37) Section 5b: Link to MicroPython documentation library updated Section 6a: MSL updated
1.2	Jul 7, 2024	Adding the following section: Section 7: Certification Section 8: Part number/Model no. comparison table
1.3	Aug 13, 2024	Updating following section: Section 7b: FCC Statements

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FAQs


- **Q: How do I update the firmware of the F1 Smart Module?**

A: To update the firmware, please follow the steps outlined in the user manual provided with the module.

- **Q: Can I use multiple F1 Smart Modules together in a network?**

A: Yes, you can use multiple modules together to create a network. Refer to the user manual for detailed instructions on network setup.

Documents / Resources

	SG F1 Smart Module [pdf] Owner's Manual SGW3531, SGW3501, SGW3431, SGW3401, SGW3231, SGW3201, SGW3131, SGW3101, F1 Smart Module, F1, Smart Module, Module
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References

- [SG/ **SG Document Hub - SG Wireless Document Hub**](#)
- [SG/ **SG Document Hub - SG Wireless Document Hub**](#)
- [SG/ **IoT innovation | SG Wireless**](#)
- [User Manual](#)

[Manuals+](#), [Privacy Policy](#)

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